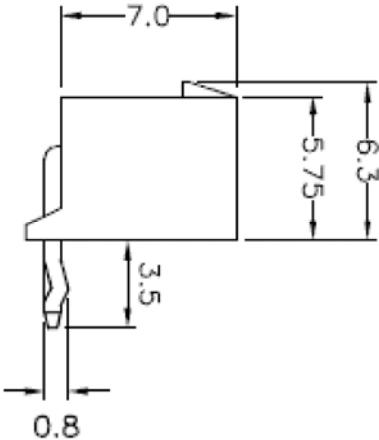
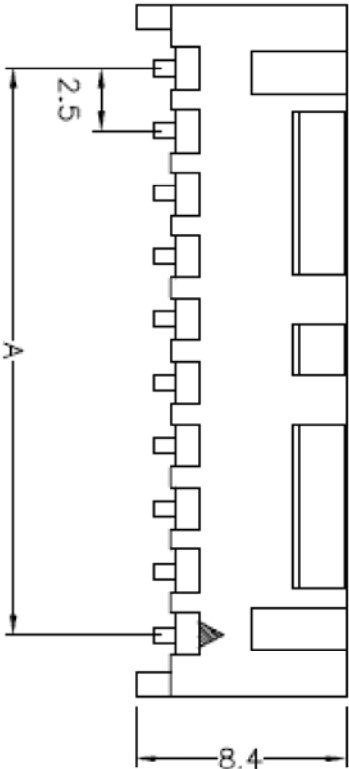
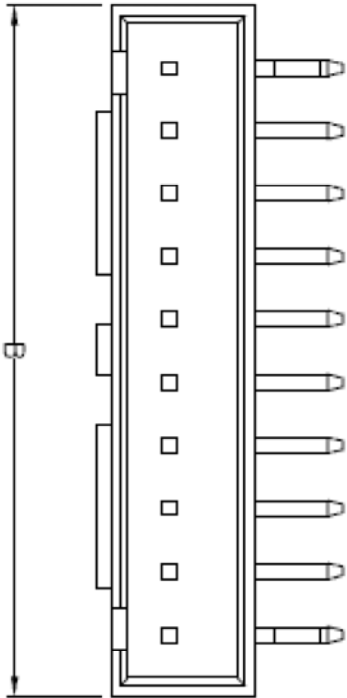




SPECIFICATIONS

- Pole:2-20
- Voltage rating:250V AC DC
- Current rating:3A AC,DC
- Withstanding voltage:1000V AC/minute
- Insulation resistance:1000MΩmin.
- Temperature range: -25℃ to+85℃
- (including temperature rise in applying electrical current)
- Applicable PC board thickness:0.063"(1.6mm)
- Contact resistance:initial value/10mΩmax.
- After environmental testing/20mΩmax.

WAFER

- Part No.:WZS1701-XXXXA03
- Poles:2-20
- Material:Contact:Brass,Tin plated
- Base:Nylon 66 UL 94V-0
- Q'ty:500,1000 pcs/bag

Ordering Information

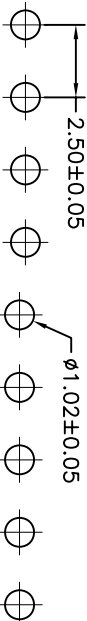
WZR1701 - XX XX A 04



No. of Pins per Row Contact Plating
02~20 01=Gold Flash
04=Tin

Duplex Plating
06=Gold Flash/Tin(100u")

Recommended PCB Layout



Poles	Dimension(mm)	
	A	B
2	2.5	7.5
3	5.0	10.0
4	7.5	12.5
5	10.0	15.0
6	12.5	17.5
7	15.0	20.0
8	17.5	22.5
9	20.0	25.0
10	22.5	27.5
11	25.0	30.0

Poles	Dimension(mm)	
	A	B
12	27.5	32.5
13	30.0	35.0
14	32.5	37.5
15	35.0	40.0
16	37.5	42.5
17	40.5	45.0
18	42.5	47.5
19	45.0	50.0
20	47.5	52.5

绘图 (DRAWN)		杨涛		投影 (PROJECT)		公差 (TOLERANCE)		料号 (PART NO)		页次 (PAGE)	
审核 (CHECKED)				单位 (UNIT)		0.0 ± 0.30		WZR1701-XXXXA04		1 / 1	

J&B 东莞市骏佳电子科技有限公司

JunJia Electronics Technology CO.LTD

审核 (APPROVE)		日期 (DATE)		品名 (NAME)	
		2006. 07. 01		XH2.5 WAFER 90度 打K	